Other Heating Sources

CoolRack* and CoolSink* modules may be used on other heating sources such as hot plates and dry baths. Please note that aluminum alloy may react with some ceramic surfaces. Check compatibility of surface prior to placing CoolRack* or CoolSink* module on it.

General Information:

- Thermo-conductivity: CoolRack" and CoolSink' modules and ThermalTray" platforms are thermo-conductive and designed for direct contact with a temperature source. They are compatible with ice, dry ice, liquid nitrogen, refrigerators, -20°C freezers, -80°C freezers, water baths, heat blocks, ovens, incubators and many other laboratory temperature sources, the modules will gradually equilibrate to room temperature. For more information on passive warming and cooling profiles, visit www.coming.com/lifesciences.
- Use of liquid crystal display (LCD) temperature strip: The LCD 1-8°C temperature strip may be affixed to any thermo-conouctive module by simply removing the paper backing to expose the adhesive strip and applying to a

flat dry surface on the module. The d'splay will indicate the temperature of the module when placed on or in a 1°C to 8°C temperature source, such as 'cc. A module bearing an LCD temperature strip may be used in other cooler or warmer temperature sources. The LCD strip is not autoclavable and should not be affixed to modules that will be autoclaved.

Care and Cleaning

All thermo-conductive modules are anodized and corrosion resistant. They may be cleaned with solvents, aqueous detergents, alcohols and acid/base viricide (such as Virkon 5) solutions. Rinse with clear water after exposure to cleaning solutions. They may be stored at room temperature or in a cooling or heating medium. Avoid soaking for extended periods (more than one hour) in low or high pH solutions. The modules are autoclavable and can be heat sterilized up to 250°C.

For more information, visit: www.corning.com/lifesciences

For additional product or technical information, and a complete listing of our international Offices and Distributors, visit www.corning.com/lifesciences or call 800.492.1110. Outside the United States, call +1.978.442.2200 or contact your local Corning sales office.

CORNING | HALCON AXYGEN GOSSELIN PYREX

For a Filing of Ludentane, vivil www.comlingsom/ds.radentane. All other trademarks are the property of their respective owners. 92015 Coming Theorpera.ed. All rights reserved. 92015 Coming Theorpera.ed. All rights reserved.

CORNING | CoolRack* CoolSink* ThermalTray*

Thermo-conductive passive temperature regulating modules for use on common laboratory cooling, freezing, warming sources such as ice, dry ice, liquid nitrogen (LN2), waterbath or other compatible cooling or heat sources.

Instructions for Use

Thermo-conductive CoolRack* and CoolSink* tube and plate modules and ThermalTray** platforms are designed to regulate temperature through direct contact with a cooling, freezing, or heating source (-196°C through >100°C). hey will rapidly adapt to the source temperature. This method of cooling or heating replaces direct insertion of tubes and/or plates into or onto the temperature source, allowing for more uniform temperature amongst the individual samples, reproducible cooling, freezing or warming, increased organization and minimized risk of contamination.

△ CAUTION: Direct skin contact with metal surfaces at uitro-low or cryogenic temperatures or when heated can cause serious burns. Never touch frozen or heated metal surfaces with bare skin. Always use insulated protective gloves when handling modules in dry ice, liquid nitrogen or any heat source. Follow all applicable slandard laboratory safety procedures.

Benchtop Cooling with Ice

Fill ice bucket with ice and place CoolRack® or CoolSink® module directly or top of the ice. The module will cool below 4°C within two minutes and will stay below 4°C as long as it remains in contact with solid ice or water that contains solid ice p'eces. It is not necessary to pre-cool module prior to placing on ice. Replenish ice as desired for longer cooling duration.

If using a ThermalTray" platform for extended cooling duration, fill a Corning 9L rectangular ice part half way with ice. Press the ThermalTray" platform into the ice pack until fully seated. The ice level should reach the underside of the ThermalTray" platform. Place CoolRack* or CoolSink* module(s) onto

the ThermalTray ¯ platform and allow to reach <4°C temperature (about 5 minutes). The modules will remain below 4°C for as long as solid ice remains in the melt water (typically 8-10 hours or longer, depending on ambient condicions). Replenish ice as desired for longer cooling durations. Avoid exposure to hot lights or strong air currents for optimal temperature stability.

Ice-free Benchtop Cooling

For an alternate method of benchtop cooling without ice, some CoolRack* and CoolSink* thermo-conductive modules are compatible with Corning CoolBox" ice-free systems. Pairing a CoolRack* or CoolSink* module with a CoolBox" system will provide hours of ice-free cooling (0.5 to 4*C) or freezing (-20 to 0*C). For more information, visit www.corning.com/life sciences.

Snap Freezing in Dry Ice

Place enough dry ice into an insulated pan to create a 1.5 inch (4 cm) bed of dry ice under the entire surface of the Coolkack or Coolsink module. Place module on the dry ice. Allow approximately 7-8 minutes for the module to equilibrate to dry ice temperature (approx.

-78°C). Insert tubes or plates into the module to snap freeze. Replen'sh dry ice as desired for longer cooling duration. Note that while cooling down, modules may briefly emit a ringing tone due to CO2 emissions beneath the module.

CoolRack^a and CoolSink^a modules will provide a solid work surface on dry ice. It is not necessary to use a ThermalTray^a platform when working with dry ice. It is not necessary to pre-cool the CoolRack^a or CoolSink^a. It is not necessary to add ethanol or any alcohol to the dry ice.

Cryogenic Benchtop Handling in Liquid Nitrogen (LN2)

A ThermalTray* may be used, but is not required, when using CoolRack® and CoolSink® modules with liquid nitrogen.

If using a ThermalTray" platform, place ThermalTray" into an insulated pan. A Corning 91 rectangular ice pan is ideal. Add LN2 to the pan until the level reaches just below the table height of the platform. Place CoolRack or CoolSink' module(s) onto the platform and allow approximately 15 minutes to reach cryogenic temperature

(approx. -150°C). The modules will remain at cryogenic temperature for as long as liquid nitrogen contacts the fins of the ThermalTray*. Replenish LN2 as desired for longer cooling duration.

If NOT using a ThermalTray* platform, place CoolRack* or CoolSink* module in a Corning insulated ice pan. Add LN2 to the pan until it covers half the height of the module. Allow approximately 15 minutes for the module to equilibrate to cryogenic temperature (approx. -150°C). Replenish LN2 as required.

Heating / Thawing in a Water Bath

Place a ThermalTray" placform into a water bath. (A minimum dear area of 12 x 6 in. with a minimum depth of 5 in. is ideal.) Place CoolRack' or CoolSink' module(s) onto the platform. Maintain a water level that is at or slightly above the level of the platform surface. Allow approximately 10 minutes for the modules to equilibrate to bath temperature. It may be necessary to offset bath temperature by approx. 17C to maintain desired module temperature.